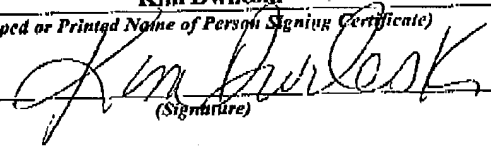


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|---|-------------------------------|---------------------------------------|--------------------------------------|
| CERTIFICATE OF TRANSMISSION BY FACSIMILE (37 CFR 1.8) Applicant(s): Bernier et al. | | | Docket No. END920010026US1 |
| Application No. 09/885,853 | Filing Date 6/20/01 | Examiner William D. Coleman | Group Art Unit 2823 |
| Invention: EXTENSION OF FATIGUE LIFE FOR C4 SOLDER BALL TO CHIP CONNECTION | | | |
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| I hereby certify that this <u>Request for Reconsideration (14 pages)</u> (Identify type of correspondence) is being facsimile transmitted to the United States Patent and Trademark Office (Fax. No. <u>703-872-9306</u>) on <u>9/29/2004</u> (Date) | | | |
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P18/REV02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Bernier *et al.*

Art Unit: 2823

Serial No.: 09/885,853

Dkt. No.: END920010026US1

Filed: 6/20/01

Examiner: William D. Coleman

Title: **EXTENSION OF FATIGUE LIFE FOR C4 SOLDER BALL TO CHIP CONNECTION**

Commissioner for Patents
P.O. Box 1450
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Request for Reconsideration

Sir:

This Request for reconsideration is in response to the Final Office Action mailed
September 20, 2004.

09/885,853

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